

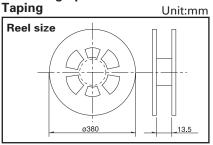
Low-profile and compact size of 3.7×3.7×0.35mm.

Typical Specifications				
Items	Specifications			
Rating (max.)	50mA 12V DC			
Rating (min.)	10µA 1V DC			
Initial contact resistance	100mΩ max.			
Travel (mm)	0.15			

Product Line

Due due t Nie	On another former	On such in a dimention	Operating life	Minimum order unit (pcs.)		
Product No.	Operating force	Operating direction	ing direction (5mA 5V DC)		Export	
SKRWAEE030	1.57N	Toppush	500,000cycles	10.000	10.000	
SKRWADE030	2.35N	Toppush	50,000cycles	10,000	10,000	

Packing Specifications



Numb	per of packages		Export package		
1 reel	1 case / Japan	1 case / export packing	Tape width (mm)	measurements (mm)	
10,000	100,000	100,000	12	401 × 401 × 214	

Note

For reels of 330mm diameter, please inquire.

Dimensions

Radial Туре

Sharp Feeling Soft

Feeling Snap-in

Туре

Surface Mount Type

Detector

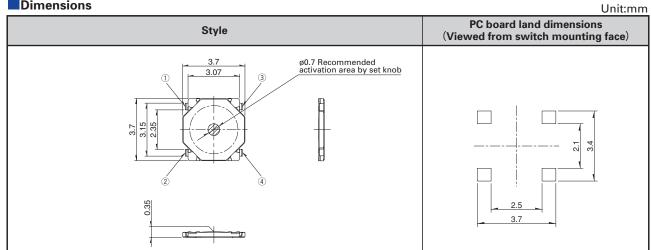
Push

Slide

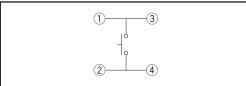
Rotary

Encoders

Power Dual-in-line Package Type TACT Switch[™]



Circuit Diagram





	Туре	Eno	p–in			Shar	p Feeling	I ype	unt			
	eries	SKQJ	SKQB	SKSH	SKRW	SKRM	SKRB	SKRR	SKQG	SKTC	SKSK	SKSD
	Photo								- () -			
Eo	atures					profile		Low-profile	Low-		ouble actio	
								and long life	profile			
Wat	er-proof		•		0					•		
Dus	st-proof	•	•	0	0	0	0	0	0	•		
erating	Toppush		_	•	•	•	•	•	•	•	•	•
ection	Sidepush	•	•	_	_	_	_	_	_	_	_	_
	W	7.5	11.5	3.3	3.7	4.5	4.8	7.5	5.2	3.4	3.5	4.1
ensions nm)	D	7.85	11.9	2.9				7		2.2	3.2	3.9
	H ~1N	7.3	11.3	0.	35	0.4	0.55	0.6	0.8	0.62	0	.6
ration rce erage	1N~2N 2N~3N 3N~4N	Ļ	\$	Ţ	Ţ	Ţ	^	ŧ			*	
Trav	4N~5N	0.25	0.3	0.	15	0.15	5/0.2	0.:	25		*	
	d terminal				_	_		_			•	•
erating	g temperature	−20℃ to+70℃	-40℃ to+90℃			-30°C to	o +85℃				_	
	ange	10+700	10+90 C									
	notive use											
	e Cycle ng (max.)	*3	★3	* 2	* 2	* 2	* 2		★3	*2	* 2	* 2
(Resis	stive load)					50	mA 12V	DC				
	ng (min.) stive load)					1	0μA 1V E	DC				
al	Insulation resistance					100MΩ mi	in. 100V D	C for 1min				
ance	Voltage proof	250V AC for 1min. 100V AC for 1min. 250V AC for 1min. 100V AC for 1min. 250V AC for 1min. 100V AC for 1min. 250V AC for 1min.										
1:4-1	Vibration			10 to 55 ir	to 10Hz/m the 3 dire	nin., the am ection of X,	plitude is Y and Z f	1.5mm for for 2hours r	all the free respective	quencies, ly		
ility	Lifetime			S	Shall be in	accordanc	e with inc	lividual spe	cification	S.		
	Cold	- 30 ± 2°C for 96h	- 40 ± 2°C for 96h		-30±2°C for 96h							
nental	Dry heat	80 ± 2°C for 96h	90 ± 2°C for 96h				80	±2℃ for 9	96h			
	Damp heat	60 ± 2°C , 90 to 95%RH for 96h	60 ± 2°C , 90 to 95%RH for 1000h				60±2℃,	90 to 95%I	RH for 96h	ı		
	Page	237	239	245	246	247	248	249	250	252	253	254
	witch [™] Solderii		<u>.</u>			D: Depth	. The mo	ost outer d st outer di nimum dir	mension	excluding	terminal	portion.

Notes
The automotive operating temperature range to be individually discussed upon request.
O indicates applicability to all products in the series, while ○ indicates applicability to some products in the series.

3. % See the relevant pages for respective product descriptions



TACT Switch[™] Soldering Conditions

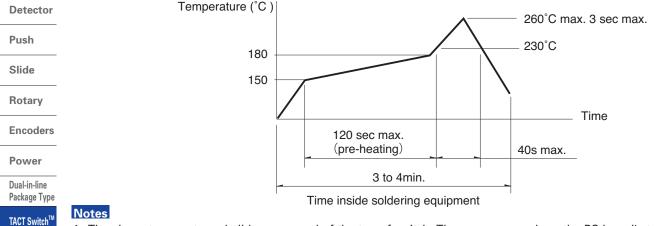
Condition for Reflow

Available for Surface Mount Type.

- 1. Heating method: Double heating method with infrared heater.
- 2. Temperature measurement: Thermocouple 0.1 to 0.2 ϕ CA (K) or CC (T) at solder joints (copper foil surface).

A heat resistive tape should be used to fix thermocouple.

3. Temperature profile



1. The above temperature shall be measured of the top of switch. There are cases where the PC board's temperature greatly differs from that of the switch, depending on the material, size, thickness of PC boards and others. The above-stated conditions shall also apply to switch surface temperatures.

2. Soldering conditions differ depending on reflow soldering machines. Prior verification of soldering condition is highly recommended.

Conditions for Auto-dip Available for Snap-in Type and Radial Type

· ·	
ltems	Condition
Flux built-up	Mounting surface should not be exposed to fluk
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100 $^\circ C$ max.
Preheating time	60s max.
Soldering temperature	260°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

SKHH、SKPD Series

ltems	Condition		
Flux built-up	Mounting surface should not be exposed to fluk		
Preheating temperature	Ambient temperature of the soldered surface of PC board. 110°C max.		
Preheating time	60s max.		
Soldering temperature	260°C max.		
Duration of immersion	5s max.		
Number of soldering	2times max.		

SKQJ、SKQK、SKEG Series

Items	Condition
Flux built-up	Mounting surface should not be exposed to fluk
Preheating temperature	Ambient temperature of the soldered surface of PC board. 100°C max.
Preheating time	45s max.
Soldering temperature	255°C max.
Duration of immersion	5s max.
Number of soldering	2times max.

Notes

- 1. Consult with us for availability of TACT Switch[™] washing.
- 2. Prevent flux penetration from the top side of the TACT SwitchTM.
- 3. Switch terminals and a PC board should not be coated with flux prior to soldering.
- 4. The second soldering should be done after the switch is stable with normal temperature.
 - 5. Use the flux with a specific gravity of min 0.81.
 - (EC-19S-8 by TAMURA Corporation, or equivalents.)

Manual Soldering (Except SKRT Series)

Items	Condition
Soldering temperature	350°C max.
Duration of soldering	3s max.
Capacity of soldering iron	60W max.

SKHH、SKHW、SKRG、SKPD Series

Items	Condition	
Soldering temperature	360°C max.	
Duration of soldering	3s max.	
Capacity of soldering iron	60W max.	

SKQJ、SKQK、SKEG Series

Items	Condition	
Soldering temperature	350°C max.	
Duration of soldering	3s max.	
Capacity of soldering iron	20W max.	



Sharp Feeling Soft

Feeling Snap-in Type Surface Mount Type

Radial Type